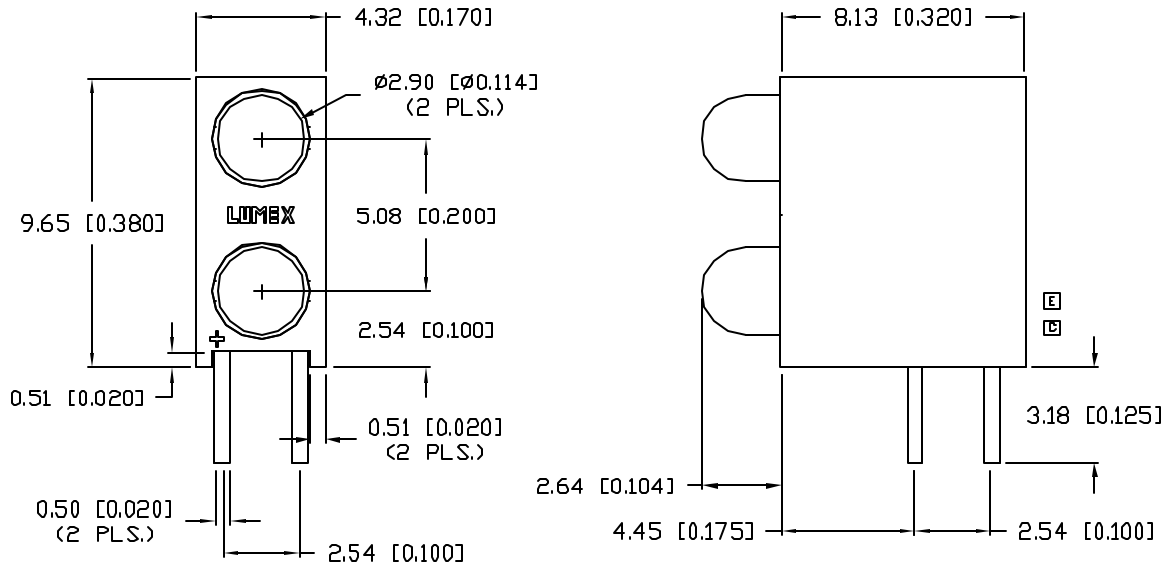


UNCONTROLLED DOCUMENT

UNDER REVISION



SC:0.25	PART NUMBER	REV.
	SSF-LXH240IID	H

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	CHG'D LEAD LENGTHS.	8.9.93
B	CHG'D LEAD LENGTHS.	8.27.93
C	CHG'D HOLDER BOTTOM & SAFE OP. SPECS.	8.19.94
D	UPDATED SPECS.	11.29.94
E	CHG'D STAND-OFF TO 4 FOOD CONSTR.	1.9.95
F	E.C.N. #10100.	10.9.95
G	E.C.N. #10104.	2.6.96
H	E.C.N. #10BRDR. & REDRAWN.	3.5.01

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		635		nm	
		635		nm	
FORWARD VOLTAGE		2.0	2.8	V _f	
REVERSE VOLTAGE	5.0			V _r	I _r =100 μ A
AXIAL INTENSITY		15		mcd	I _f =20mA
VIEWING ANGLE		80		2x theta	
EMITTED COLOR:	RED/RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	COLORS	MAX	UNITS
PEAK FORWARD CURRENT*		150	mA
STEADY CURRENT		30	mA
POWER DISSIPATION		105	mW
DERATE FROM 25°C		-1.2	mW/°C
OPERATING, STORAGE TEMP.		-40 TO +85	°C
SOLDERING TEMP.		+260	°C
2.0mm FROM BODY			J SEC. MAX

* t < 10 μ s

NOTES:

- SSH-LXH240 HOLDER, MATERIAL: BLACK NYLON 94V-0.
- SSL-LX3044ID LED (2 PCS.).

UNCONTROLLED DOCUMENT

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.=+DECIMAL PRECISION MAX.=+0.00 -DECIMAL PRECISION

REV.	PART NUMBER
H	SSF-LXH240IID

CONFIDENTIAL INFORMATION
 THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.

LUMEX
 290 E. HELEN ROAD
 PALATINE, IL 60067-6976
 PHONE: +1.847.359.2790
 US WEB: www.lumex.com
 TW WEB: www.lumex.com.tw

T-3mm RIGHT ANGLE FAULT INDICATOR LED,
 DUAL 635nm RED LEDS, RED DIFFUSED.

RELIABILITY NOTE
 OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE:
CT			1.12.93
			PAGE: 1 OF 1
			SCALE: N/A